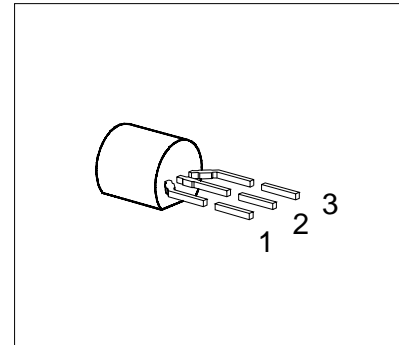


## SIPMOS® Small-Signal Transistor

## BSS 229

- $V_{DS}$  250 V
- $I_D$  0.07 A
- $R_{DS(on)}$  100  $\Omega$
- N channel
- Depletion mode
- High dynamic resistance
- Available grouped in  $V_{GS(th)}$



Type	Ordering Code	Tape and Reel Information	Pin Configuration			Marking	Package
			1	2	3		
BSS 229	Q62702-S600	E6296: 1500 pcs/reel; 2 reels/carton; source first	G	D	S	SS229	TO-92

### Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	$V_{DS}$	250	V
Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$	$V_{DGR}$	250	
Gate-source voltage	$V_{GS}$	$\pm 20$	
ESD Sensitivity (HBM) as per MIL-STD 883	—	Class 1	
Continuous drain current, $T_A = 25 \text{ }^\circ\text{C}$	$I_D$	0.07	A
Pulsed drain current, $T_A = 25 \text{ }^\circ\text{C}$	$I_{D \text{ puls}}$	0.21	
Max. power dissipation, $T_A = 25 \text{ }^\circ\text{C}$	$P_{tot}$	0.63	W
Operating and storage temperature range	$T_j, T_{stg}$	$-55 \dots +150$	$^\circ\text{C}$
Thermal resistance, chip-ambient (without heat sink)	$R_{thJA}$	$\leq 200$	K/W
DIN humidity category, DIN 40 040	—	E	—
IEC climatic category, DIN IEC 68-1	—	55/150/56	

## Electrical Characteristics

at  $T_j = 25\text{ °C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

## Static Characteristics

Drain-source breakdown voltage $V_{GS} = -3\text{ V}$ , $I_D = 0.25\text{ mA}$	$V_{(BR)DSS}$	250	–	–	V
Gate threshold voltage $V_{DS} = 3\text{ V}$ , $I_D = 1\text{ mA}$	$V_{GS(th)}$	– 1.8	– 1.4	– 0.7	
Drain-source cutoff current $V_{DS} = 250\text{ V}$ , $V_{GS} = -3\text{ V}$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	$I_{DSS}$	– –	– –	100 200	nA $\mu\text{A}$
Gate-source leakage current $V_{GS} = 20\text{ V}$ , $V_{DS} = 0$	$I_{GSS}$	–	10	100	nA
Drain-source on-resistance $V_{GS} = 0\text{ V}$ , $I_D = 0.014\text{ A}$	$R_{DS(on)}$	–	75	100	$\Omega$

## Dynamic Characteristics

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$ , $I_D = 0.07\text{ A}$	$g_{fs}$	0.05	0.10	–	S
Input capacitance $V_{GS} = 0$ , $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$	$C_{iss}$	–	85	120	pF
Output capacitance $V_{GS} = 0$ , $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$	$C_{oss}$	–	6	10	
Reverse transfer capacitance $V_{GS} = 0$ , $V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$	$C_{rss}$	–	2	3	
Turn-on time $t_{on}$ , ( $t_{on} = t_{d(on)} + t_r$ ) $V_{DD} = 30\text{ V}$ , $V_{GS} = -2\text{ V} \dots +5\text{ V}$ , $R_{GS} = 50\text{ }\Omega$ , $I_D = 0.15\text{ A}$	$t_{d(on)}$	–	4	6	ns
	$t_r$	–	10	15	
Turn-off time $t_{off}$ , ( $t_{off} = t_{d(off)} + t_f$ ) $V_{DD} = 30\text{ V}$ , $V_{GS} = -2\text{ V} \dots +5\text{ V}$ , $R_{GS} = 50\text{ }\Omega$ , $I_D = 0.15\text{ A}$	$t_{d(off)}$	–	10	13	
	$t_f$	–	15	20	

**Electrical Characteristics (cont'd)**

at  $T_j = 25\text{ °C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse Diode					
Continuous reverse drain current $T_A = 25\text{ }^{\circ}\text{C}$	$I_S$	—	—	0.07	A
Pulsed reverse drain current $T_A = 25\text{ }^{\circ}\text{C}$	$I_{SM}$	—	—	0.21	
Diode forward on-voltage $I_F = 0.14\text{ A}$ , $V_{GS} = 0$	$V_{SD}$	—	0.8	1.2	V

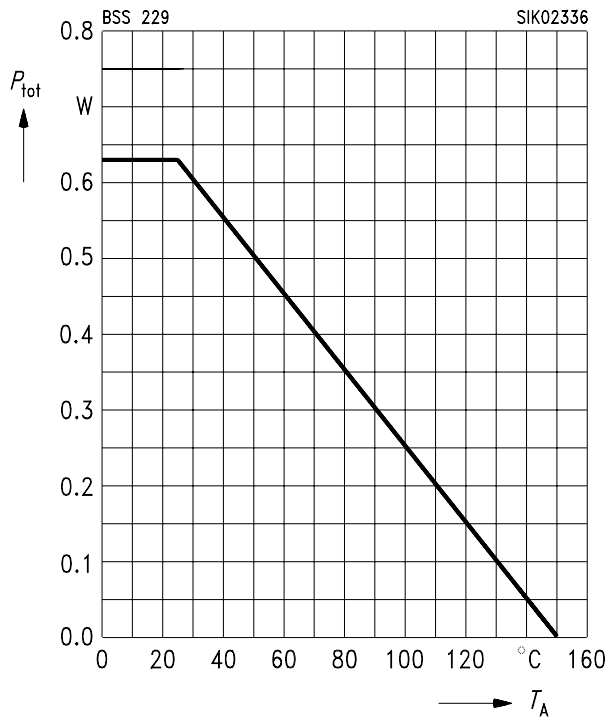
$V_{GS(th)}$ Grouping	Symbol	Limit Values		Unit	Test Condition
		min.	max.		
Range of $V_{GS(th)}$	$\Delta V_{GS(th)}$	–	0.15	V	–
Threshold voltage selected in groups: <sup>1)</sup>	$V_{GS(th)}$				$V_{DS1} = 0.2\text{ V};$ $V_{DS2} = 3\text{ V};$ $I_D = 10\text{ }\mu\text{A}$
F		– 1.535	– 1.385	V	
G		– 1.635	– 1.485	V	
A		– 1.735	– 1.585	V	
B		– 1.835	– 1.685	V	
C		– 1.935	– 1.785	V	
D		– 2.035	– 1.885	V	

1) A specific group cannot be ordered separately.  
Each reel only contains transistors from one group.

## Characteristics

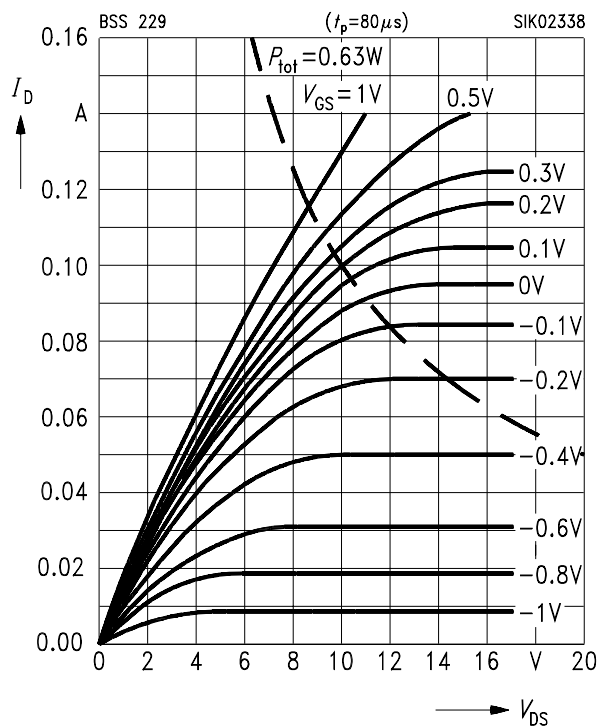
at  $T_j = 25^\circ\text{C}$ , unless otherwise specified.

Total power dissipation  $P_{\text{tot}} = f(T_A)$



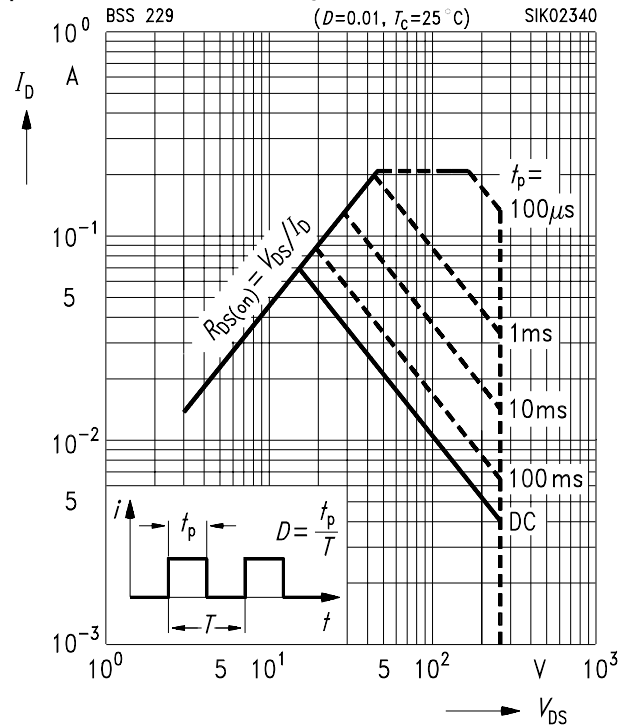
Typ. output characteristics  $I_D = f(V_{\text{DS}})$

parameter:  $t_p = 80\ \mu\text{s}$



Safe operating area  $I_D = f(V_{\text{DS}})$

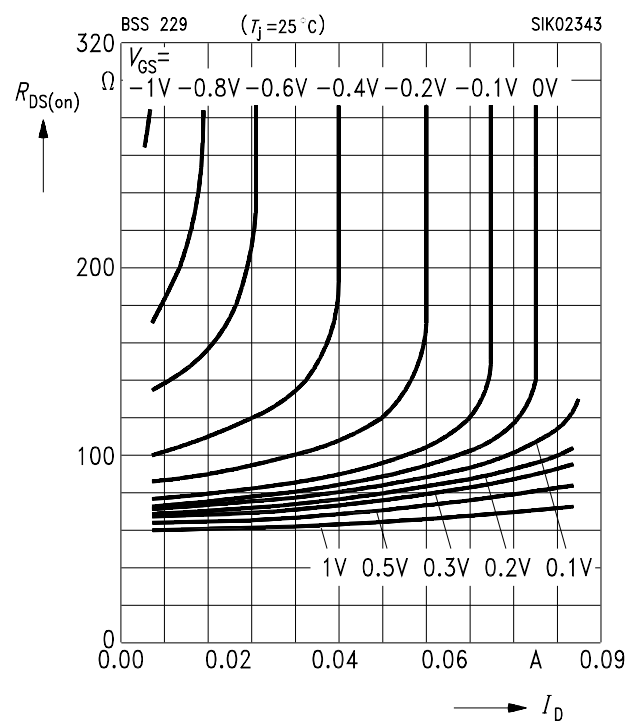
parameter:  $D = 0.01$ ,  $T_C = 25^\circ\text{C}$



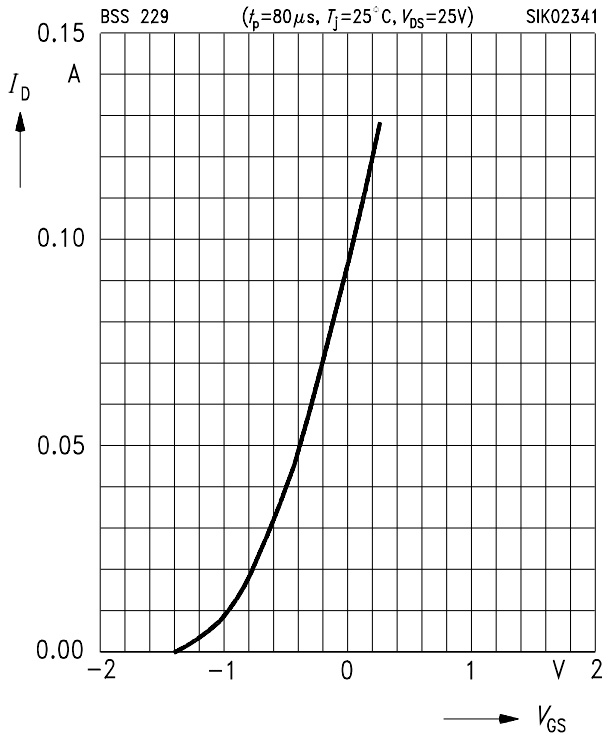
Typ. drain-source on-resistance

$R_{\text{DS(on)}} = f(I_D)$

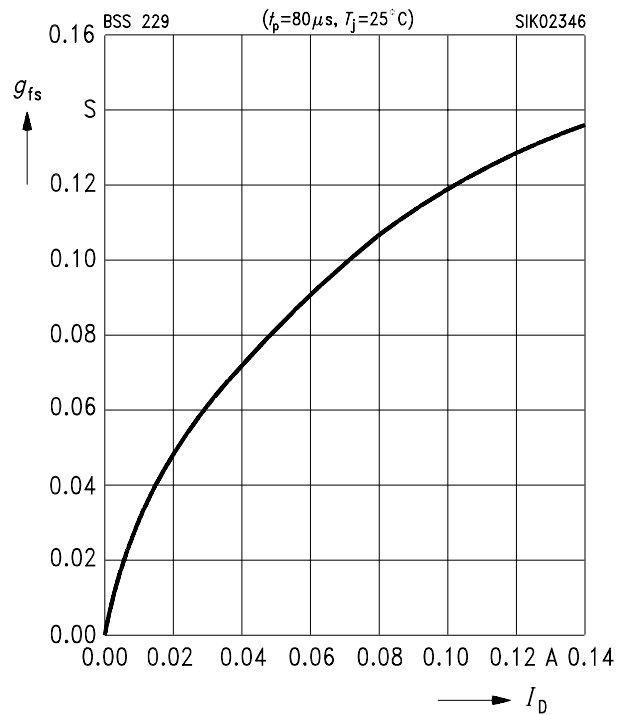
parameter:  $V_{\text{GS}}$



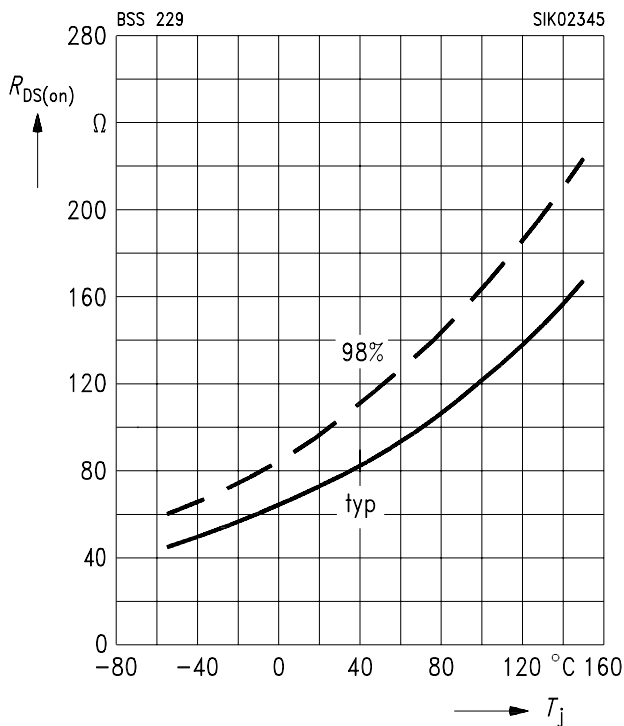
**Typ. transfer characteristics**  $I_D = f(V_{GS})$   
parameter:  $t_p = 80 \mu s$ ,  $V_{DS} \geq 2 \times I_D \times R_{DS(on)max.}$



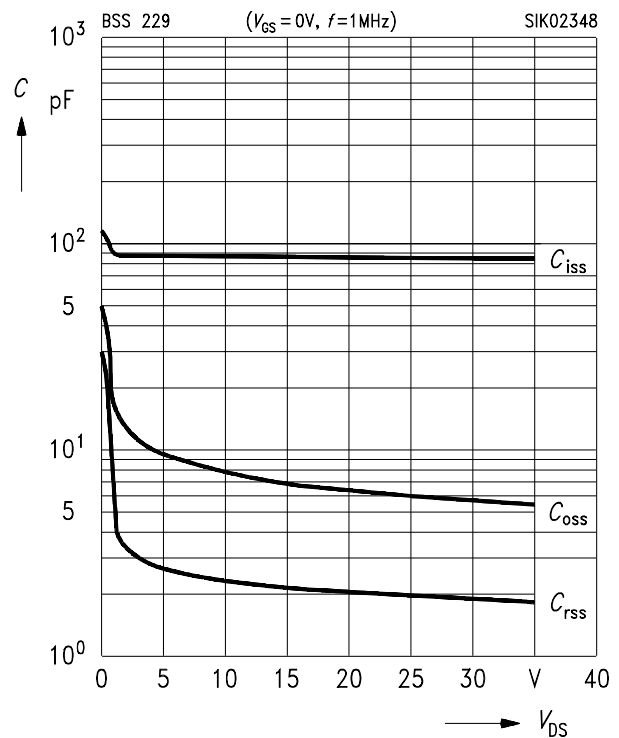
**Typ. forward transconductance**  $g_{fs} = f(I_D)$   
parameter:  $V_{DS} \geq 2 \times I_D \times R_{DS(on)max.}$ ,  $t_p = 80 \mu s$



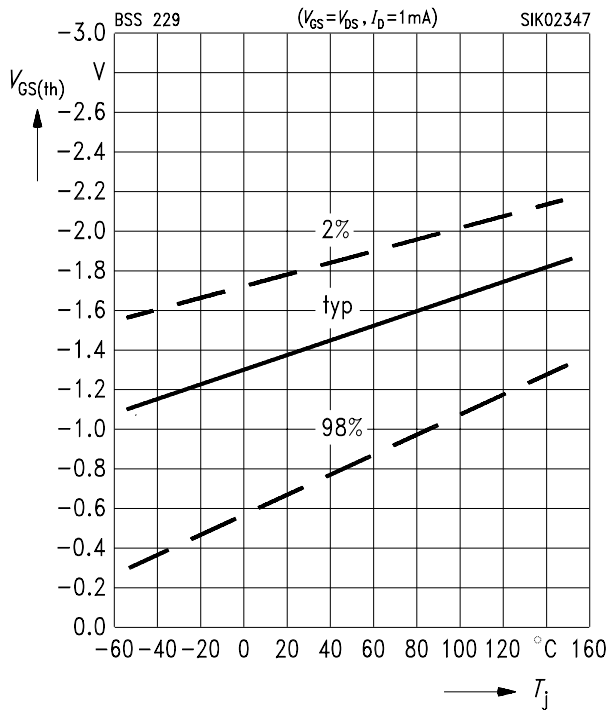
**Drain-source on-resistance**  
 $R_{DS(on)} = f(T_j)$   
parameter:  $I_D = 0.014 A$ ,  $V_{GS} = 0 V$ , (spread)



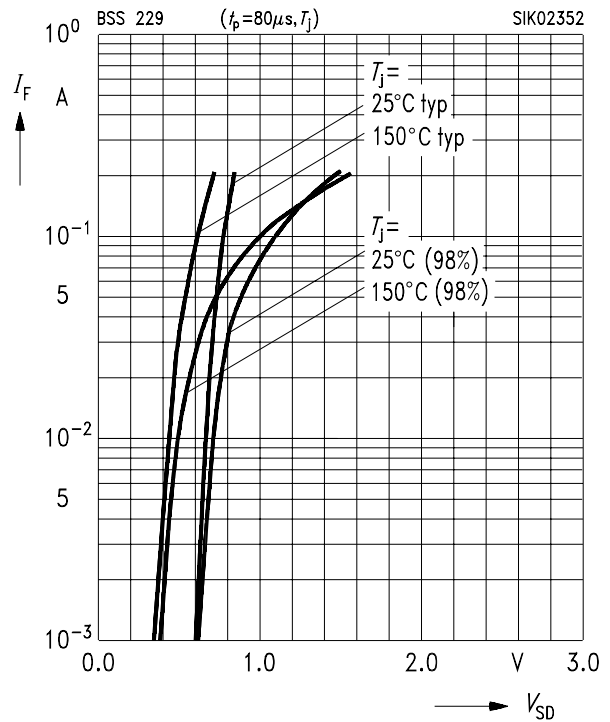
**Typ. capacitances**  $C = f(V_{DS})$   
parameter:  $V_{GS} = 0 V$ ,  $f = 1 MHz$



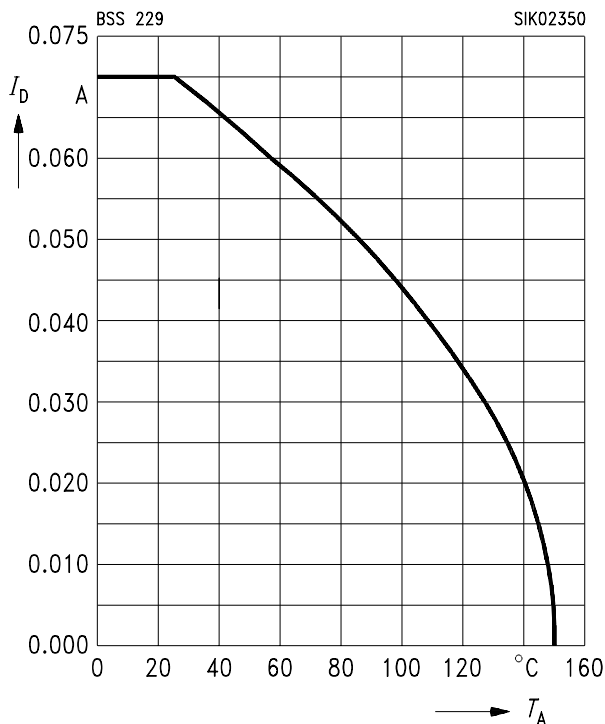
**Gate threshold voltage**  $V_{GS(th)} = f(T_j)$   
parameter:  $V_{DS} = 3\text{ V}$ ,  $I_D = 1\text{ mA}$ , (spread)



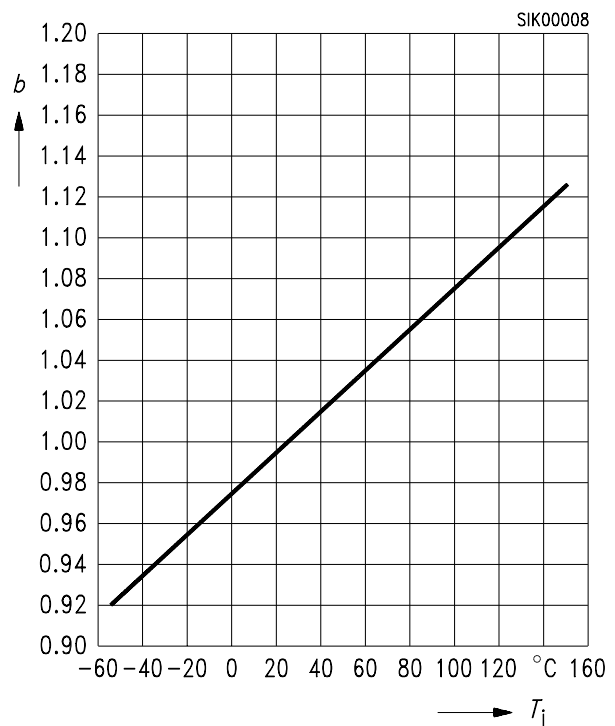
**Forward characteristics of reverse diode**  
 $I_F = f(V_{SD})$   
parameter:  $t_p = 80\text{ }\mu\text{s}$ ,  $T_j$ , (spread)



**Drain current**  $I_D = f(T_A)$   
parameter:  $V_{GS} \geq 3\text{ V}$



**Drain-source breakdown voltage**  
 $V_{(BR)DSS} = b \times V_{(BR)DSS}(25^\circ\text{C})$



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